

COMPLIANT

Vishay High Power Products

HEXFRED® Ultrafast Soft Recovery Diode, 4 A



PRODUCT SUMMARY				
V _R	600 V			
V _F at 4 A at 25 °C	1.8 V			
I _{F(AV)}	4 A			
t _{rr} (typical)	17 ns			
T _J (maximum)	150 °C			

FEATURES

- Ultrafast recovery time
- Ultrasoft recovery
- Very low I_{RRM}
- Very low Q_{rr}
- · Guaranteed avalanche
- · Specified at operating temperature
- · Lead (Pb)-free
- · Designed and qualified for Q101 level

BENEFITS

- Reduced RFI and EMI
- Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- · Reduced parts count

DESCRIPTION/APPLICATIONS

These diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for freewheeling, flyback, power converters, motor drives, and other applications where high speed and reduced switching losses are design requirements.

ABSOLUTE MAXIMUM RATINGS	-			
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Cathode to anode voltage	V _{RRM}		600	V
Maximum continuous forward current	I _{F(AV)}	T _C = 100 °C	4	
Single pulse forward current	I _{FSM}		25	Α
Repetitive peak forward current	I _{FRM}	T _C = 116 °C	16	
Maximum power dissipation	P _D	T _C = 100 °C	10	W
Operating junction and storage temperatures	T _J , T _{Stg}		- 55 to 150	°C

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Breakdown voltage, blocking voltage	V _{BR} ,	Ι _R = 100 μΑ	600	-	-		
The later was		I _F = 4 A	-	1.5	1.8	V	
Forward voltage See fig. 1	V _F	I _F = 8 A	-	1.8	2.2		
Goo lig. 1		I _F = 4 A, T _J = 125 °C	-	1.4	1.7		
Maximum reverse		$V_R = V_R$ rated	-	0.17	3.0		
leakage current		$T_J = 125 ^{\circ}\text{C}, V_R = 0.8 \text{x} V_R \text{rated}$	-	44	300	- μΑ	
Junction capacitance	C _T	V _R = 200 V	-	4	8	pF	
Seri <mark>es ind</mark> uctance	L _S	Measured lead to lead 5 mm from package body -		8.0	ı	nΗ	

Po containing terminations are not RoHS compliant, exemptions may apply

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DYNAMIC RECOVERY CHARACTERISTICS (T _C = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS	
	I _F = 1.0 A, dI _F /dt = 2		200 A/μA, V _R = 30 V	=	17	-		
Reverse recovery time	t _{rr}	T _J = 25 °C	I _F = 4 A	=	28	42	ns	
		T _J = 125 °C		=	38	57		
Peak recovery current I _{RRM}	I _{RRM}	T _J = 25 °C		-	2.9	5.2		
		T _J = 125 °C		=	3.7	6.7	Α	
Deverse receiver charge	verse recovery charge Q _{rr}	0	T _J = 25 °C	$dI_F/dt = 200 \text{ A/}\mu\text{s}$ $V_B = 200 \text{ V}$	=	40	60	~C
Reverse recovery charge Q _{rr}		T _J = 125 °C	-n	=	70	105	nC	
Rate of fall of recovery current d	dI _{(rec)M} /dt	-11 /-11	T _J = 25 °C		=	280	=	Δ/
		T _J = 125 °C		-	235	-	A/μs	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T _J , T _{Stg}		- 55	-	150	°C
Soldering temperature	T _S	10 s	-	-	240	
Thermal resistance, junction to case	R _{thJC}		-	-	5.0	°C/W
Thermal resistance, junction to ambient	R _{thJA}	Typical socket mount	-	-	80	
Weight			-	2.0	-	g
vveigni			-	0.07	-	OZ.
Mounting torque			6.0 (5.0)	-	12 (10)	kgf ⋅ cm (lbf ⋅ in)
Marking device		Case style D-PAK		HFA04SD60S		





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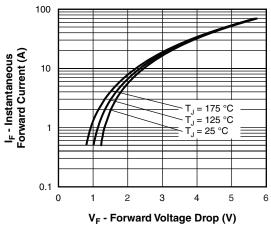


Fig. 1 - Typical Forward Voltage Drop Characteristics

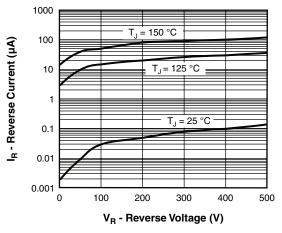


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

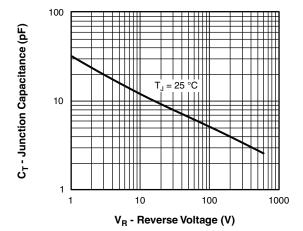


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

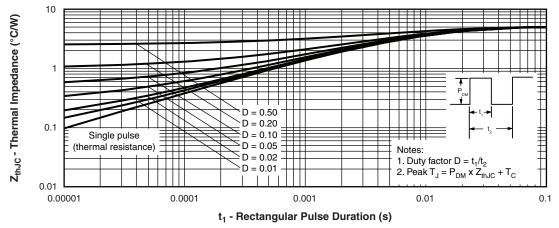


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

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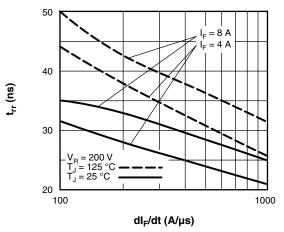


Fig. 5 - Typical Reverse Recovery Time vs. dl_F/dt

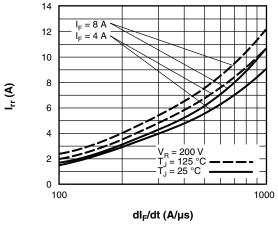


Fig. 6 - Typical Recovery Current vs. dI_F/dt

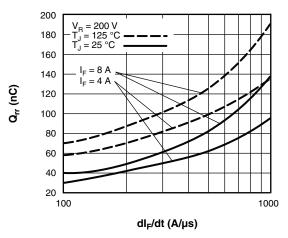


Fig. 7 - Typical Stored Charge vs. dI_F/dt

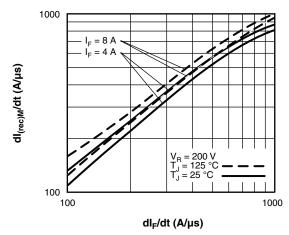


Fig. 8 - Typical $dI_{(rec)M}/dt$ vs. dI_F/dt



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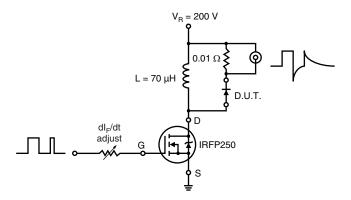
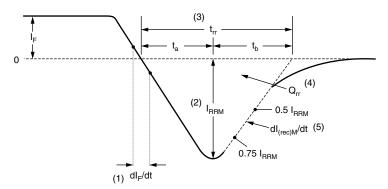


Fig. 9 - Reverse Recovery Parameter Test Circuit



- (1) dI_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) $t_{\rm rr}$ reverse recovery time measured from zero crossing point of negative going $I_{\rm F}$ to point where a line passing through 0.75 $I_{\rm RRM}$ and 0.50 $I_{\rm RRM}$ extrapolated to zero current.
- (4) \mathbf{Q}_{rr} area under curve defined by \mathbf{t}_{rr} and \mathbf{I}_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) $dI_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

Fig. 10 - Reverse Recovery Waveform and Definitions

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ORDERING INFORMATION TABLE

Device code

HFA	Α	04	SD	60	S	PbF
1	2	3	4	5	6	7

- 1 HEXFRED® family
- 2 Electron irradiated
- 3 Current rating (04 = 4 A)
- 4 D-PAK
- 5 Voltage rating (60 = 600 V)
 - Suffix —
- 7 • None = Standard production
 - PbF = Lead (Pb)-free

$S = D^2PAK/D-PAK$	
TR = Tape and reel	

TRL = Tape and reel left TRR = Tape and reel right

LINKS TO RELATED DOCUMENTS				
Dimensions http://www.vishay.com/doc?95016				
Part marking information	http://www.vishay.com/doc?95059			
Packaging information	http://www.vishay.com/doc?95033			

www.vishay.com For technical questions, contact: diodes-tech@vishay.com

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